AUTOMOTIVE

ROHS

HALOGEN

FREE GREEN

(5-2008)



Vishay Semiconductors

Ambient Light Sensor in 0805 Package



DESCRIPTION

TEMT6202FX01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 0805 package for surface mounting. The device is sensitive to the visible spectrum.

FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- · High sensitivity
- · Adapted to human eye responsivity
- Suppression filter for near infrared radiation
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>



- Automotive sensors
- Ambient light sensor for display backlight dimming in:
 - Mobile phones
 - Notebook computers
 - PDA's
 - Cameras
 - Dashboards

PRODUCT SUMMARY				
COMPONENT	I _{PCE} (μΑ)	φ (°)	λ _{0.5} (nm)	
TEMT6202FX01	16 to 30	± 60	450 to 610	

Note

· Test condition see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
TEMT6202FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805		

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Collector emitter voltage		V _{CEO}	6	V	
Emitter collector voltage		V _{ECO}	1.5	V	
Collector current		I _C	20	mA	
Power dissipation		P _V	100	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	-40 to +100	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	According to reflow profile fig. 9	T _{sd}	260	°C	
Thermal resistance junction to ambient		R _{thJA}	450	K/W	



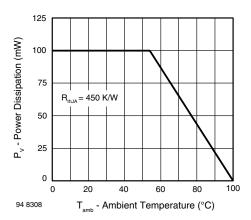


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	I _C = 0.1 mA	V_{CEO}	6	-	-	V
Collector dark current	V _{CE} = 5 V, E = 0 lx	I _{CEO}	-	3	50	nA
Collector emitter capacitance	$V_{CE} = 0 \text{ V, } f = 1 \text{ MHz, } E = 0 \text{ Ix}$	C _{CEO}	-	16	-	pF
Photo current	$E_V = 20 Ix$, CIE illuminant A, $V_{CE} = 5 V$	I _{PCE}	-	4.6	-	μΑ
	$E_V = 100 \text{ lx}$, CIE illuminant A, $V_{CE} = 5 \text{ V}$	I _{PCE}	16	23	30	μΑ
Temperature coefficient of I _{PCE}	CIE illuminant A	TK _{IPCE}	-	1.18	-	%/K
	LED, white	TK _{IPCE}	-	0.9	-	%/K
Angle of half sensitivity		φ	-	± 60	-	0
Wavelength of peak sensitivity		λ_{p}	-	550	-	nm
Range of spectral bandwidth		λ _{0.5}	-	450 to 610	-	nm
Collector emitter saturation voltage	E _V = 20 lx, 0.45 μA	V _{CEsat}	-	0.1	-	V

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

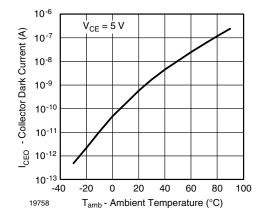


Fig. 2 - Collector Dark Current vs. Ambient Temperature

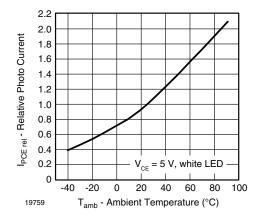


Fig. 3 - Relative Photo Current vs. Ambient Temperature

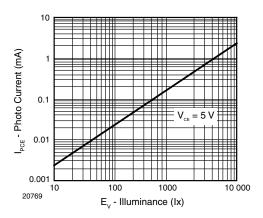


Fig. 4 - Photo Current vs. Illuminance

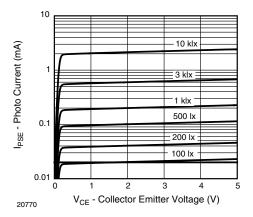


Fig. 5 - Photo Current vs. Collector Emitter Voltage

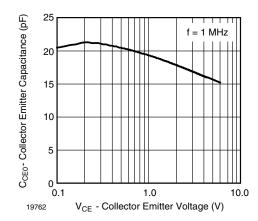


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

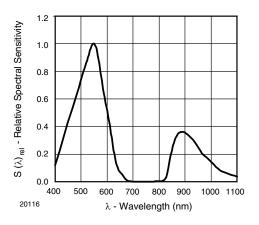


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

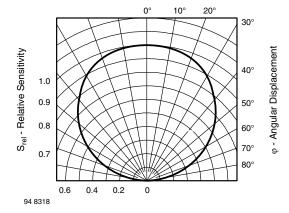


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE

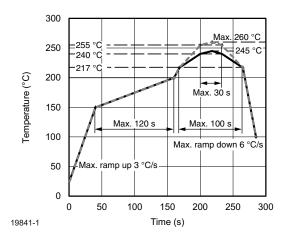


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

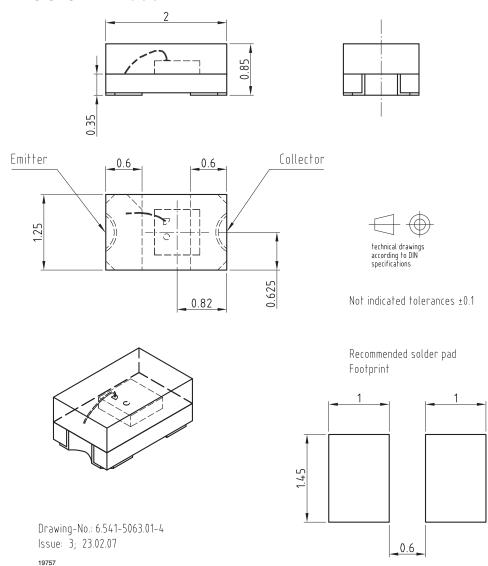
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions: 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

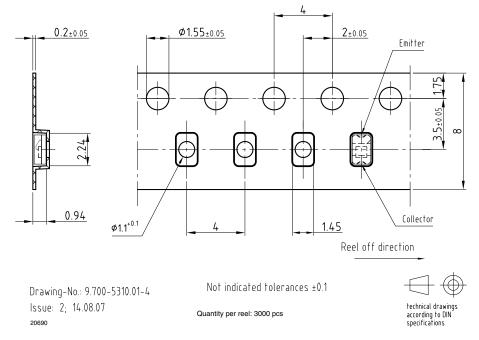
ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



PACKAGE DIMENSIONS in millimeters

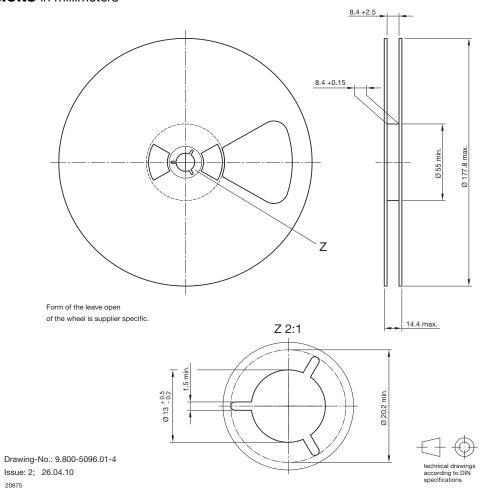


BLISTER TAPE DIMENSIONS in millimeters



REEL DIMENSIONS in millimeters

20875





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